

Product data sheet

1. General description

High voltage, high speed, planar passivated NPN power switching transistor in a SOT54 (TO-92) plastic package.

2. Features and benefits

- Fast switching
- High voltage capability
- Very low switching and conduction losses

3. Applications

- Compact fluorescent lamps (CFL)
- Electronic lighting ballasts
- Inverters
- Off-line self-oscillating power supplies

4. Pinning information

Table 1. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base		C
2	С	collector		в
3	E emitter	emitter		E sym123
			TO-92 (SOT54)	

5. Ordering information

Table 2. Ordering information						
Type number	pe number Package					
	Name	Description	Version			
BUJ100LR	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54			

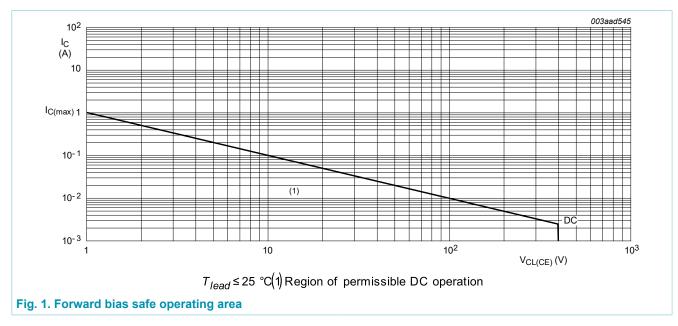
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6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CESM}	collector-emitter peak voltage	V _{BE} = 0 V	-	700	V
V _{CBO}	collector-base voltage	I _E = 0 A	-	700	V
V _{CEO}	collector-emitter voltage	I _B = 0 A	-	400	V
V _{EBO}	emitter-base voltage	I _C = 0 A; I(Emitter) = 10 mA	-	9	V
I _C	collector current	DC; <u>Fig. 1</u>	-	1	А
I _{CM}	peak collector current		-	2	А
I _B	base current	DC	-	0.5	А
I _{BM}	peak base current		-	1	А
P _{tot}	total power dissipation	T _{lead} ≤ 25 °C; <u>Fig. 2</u>	-	2.1	W
T _{stg}	storage temperature		-65	150	°C
Tj	junction temperature		-	150	°C



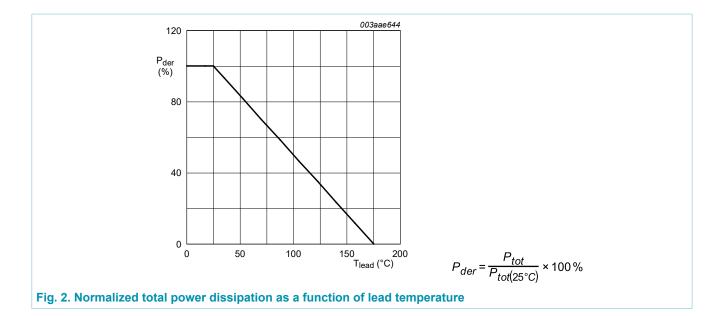
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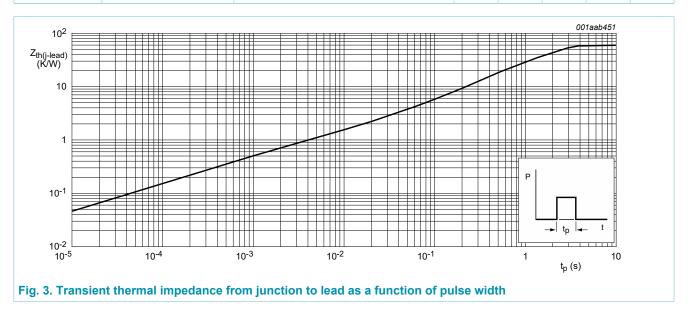


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7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	<u>Fig. 3</u>	-	-	60	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	printed circuit board mounted; lead length 4 mm	-	150	-	K/W



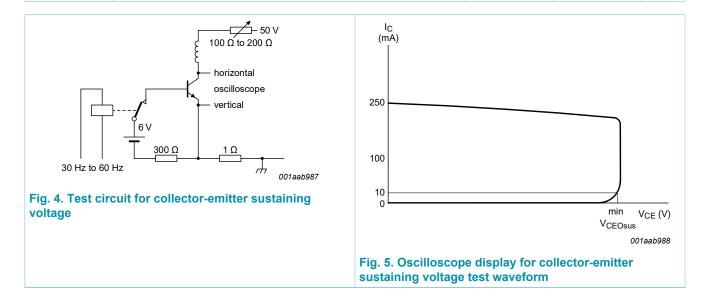
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8. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics	·				
I _{CES}	collector-emitter cut-off current (base shorted)	V _{BE} = 0 V; V _{CE} = 700 V; T _j = 125 °C	-	-	5	mA
I _{EBO}	emitter-base cut-off current (collector open)	V _{EB} = 9 V; I _C = 0 A; T _{lead} = 25 °C	-	-	1	mA
V _{CEOsus}	collector-emitter sustaining voltage (base open)	I _B = 0 A; I _C = 1 mA; L _C = 25 mH; T _{lead} = 25 °C; <u>Fig. 4; Fig. 5</u>	400	-	-	V
V _{CEsat}	collector-emitter saturation voltage	I _C = 0.25 A; I _B = 50 mA; T _{lead} = 25 °C; <u>Fig. 6</u>	-	0.2	0.5	V
		I _C = 0.5 A; I _B = 125 mA; T _{lead} = 25 °C; <u>Fig. 6</u>	-	0.3	1	V
		I_{C} = 0.75 A; I_{B} = 250 mA; T_{lead} = 25 °C; Fig. 6	-	0.4	1.5	V
V _{BEsat}	base-emitter saturation voltage	I_{C} = 0.25 A; I_{B} = 50 mA; T_{lead} = 25 °C; Fig. 7	-		1	V
		I _C = 0.5 A; I _B = 125 mA; T _{lead} = 25 °C; <u>Fig. 7</u>	-	-	1.2	V
h _{FE}	DC current gain	I_{C} = 0.5 mA; V_{CE} = 2 V; T_{lead} = 25 °C	12	-	-	
		I _C = 0.4 A; V _{CE} = 5 V; T _{lead} = 25 °C; <u>Fig. 8; Fig. 9</u>	10	-	30	
		I _C = 0.8 A; V _{CE} = 5 V; T _{lead} = 25 °C; <u>Fig. 8; Fig. 9</u>	5	7.5	20	
Dynamic ch	aracteristics	· · · · · ·				
t _f	fall time	I_{C} = 1 A; I_{Bon} = 200 mA; V_{BB} = -5 V; L_{B} = 1 µH; T_{Iead} = 25 °C; inductive load;	-	80	-	ns

Fig. 10; Fig. 11



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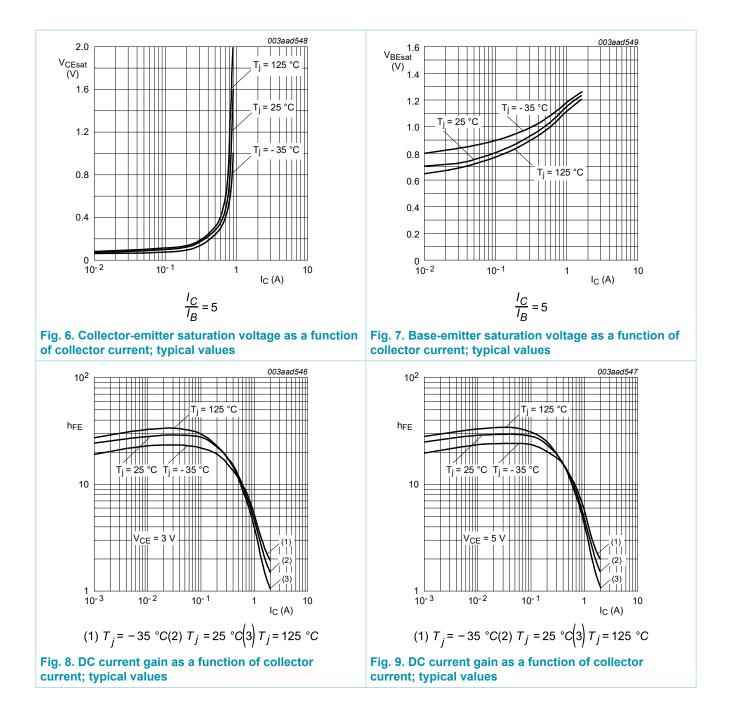
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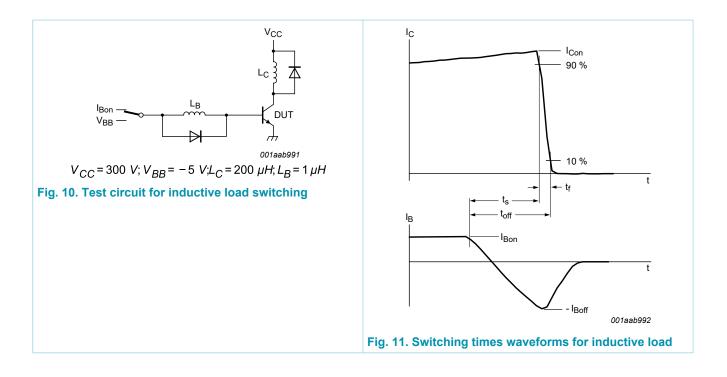
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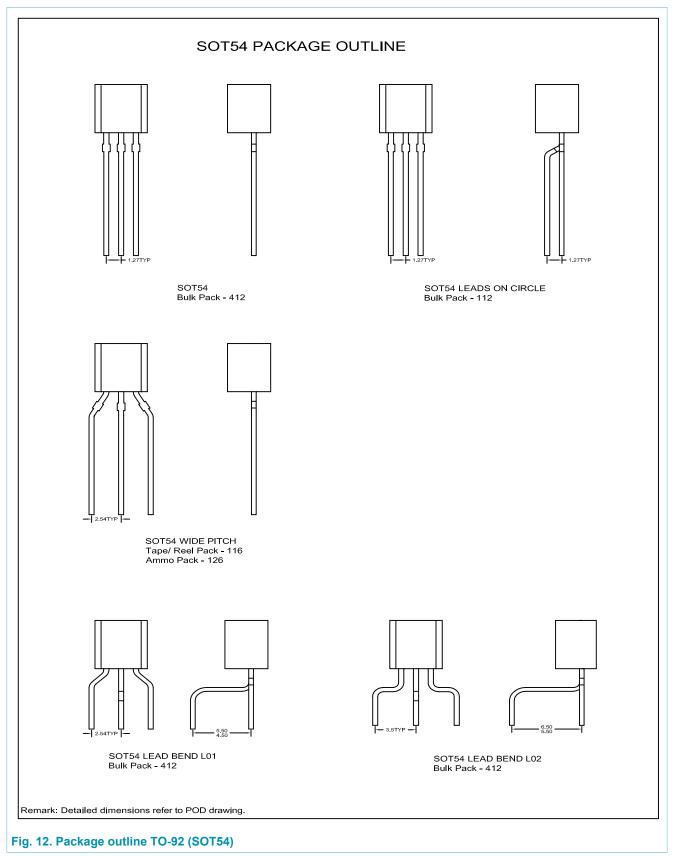
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9. Package outline



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10. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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11. Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Pinning information	1
5.	Ordering information	1
6.	Limiting values	2
7.	Thermal characteristics	4
8.	Characteristics	5
9.	Package outline	8
10	. Legal information	9

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